IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

JAN 0 4 1999

In re Patent Application of DALE R. SETLAK, ET AL.

Serial No. 08/858,144

Filed: May 16, 1997

For: ELECTRIC FIELD FINGERPRINT

SENSOR HAVING ENHANCED

FEATURES AND RELATED METHODS

Examiner: D. Novik

Art Unit: 2721

AMENDMENT

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

In response to the Official Action dated September 30, 1998, please enter the following amendments and remarks.

In the Specification:

Page 12, line 14, delete "101" and insert -- 102therefor.

In the Claims:

Please amend the claims as follows:

- (Amended) A fingerprint sensor comprising:
- a substrate;
- a plurality of semiconductor devices [adjacent] on said substrate and defining active circuit portions;
- a first metal layer on said substrate interconnecting predetermined ones of said plurality of semiconductor devices;
- a first dielectric layer [adjacent] on said first metal layer;
- dielectric layer defining a ground plane;
- a second metal layer [adjacent] on said first layer defining a ground plane; a second dielectric layer [adjacent] on said second er; and metal layer; and